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(54) Title: A COVER STRUCTURE FOR ELECTRICAL EQUIPMENT AND A WALL PANEL OF THE COVER STRUCTURE

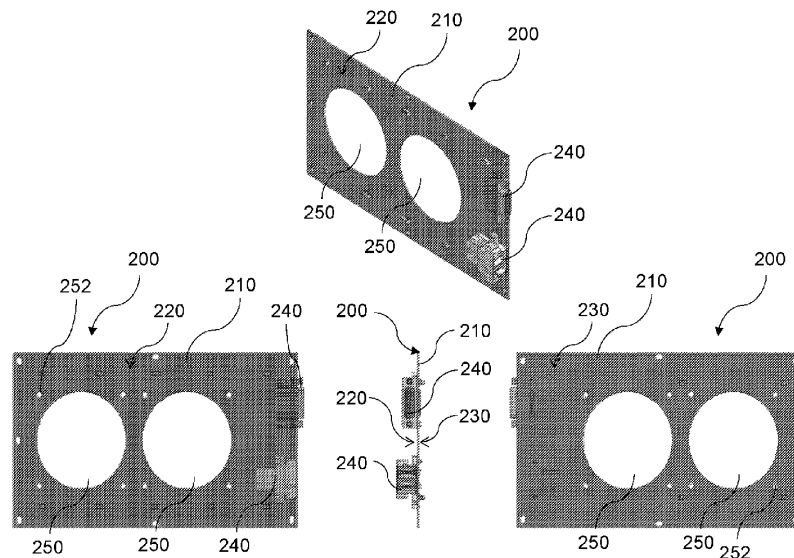


FIG. 4A

(57) Abstract: The present disclosure generally relates to a cover structure (300) for electrical equipment and a wall panel (200) of the cover structure (300). The wall panel (200) comprises: a PCB (210) integrated with the wall panel (200) such that they share a first surface (220) and a second surface (230); electrical points (240) disposed on the first surface (220) and/or the second surface (230) for receiving electrical connections from externally of the PCB (210) and/or internally from the PCB (210); electrical conduits embedded in the PCB (210) for internally connecting to the electrical points (240) on the PCB (210). The wall panel (200) is configured to provide structural support for the cover structure (300) without additional support structures at the surfaces (220, 230), such that the surfaces (220, 230) are substantially exposed for receiving electrical connections from externally of the PCB (210).

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